APPROVAL SHEET

RFBPB Series – 2012(0805)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER
- Balanced Type

Halogens Free Product

1.9 GHz PCS Band RF Application

P/N: RFBPB20121G9D0T

*Contents in this sheet are subject to change without prior notice.

FEATURES

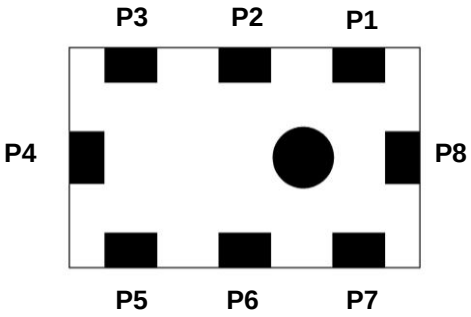
1. Miniature footprint: 2.0 X 1.2 X 0.9 mm^3.
2. Low Profile Thickness
3. Low Insertion loss
4. LTCC process

APPLICATIONS

1. 1900 MHz PCS band RF applications.

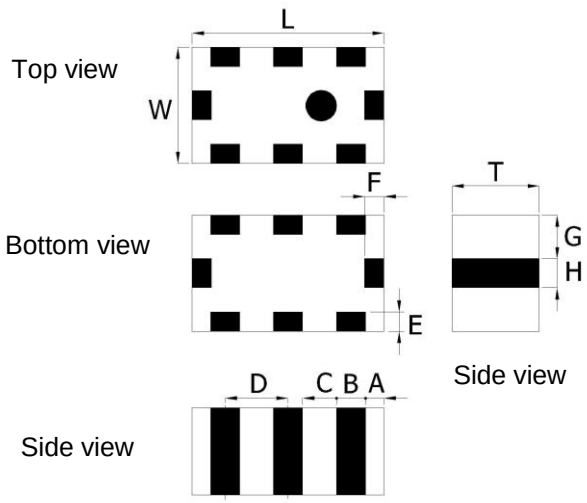
CONSTRUCTION

Top view



PIN	Connection	PIN	Connection
1	Unbalanced Port	5	Balanced Port
2	NC or DC feed port	6	GND
3	NC	7	Balanced Port
4	GND	8	GND

DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	2.00 ± 0.15
	W	1.25 ± 0.10
	T	0.90 ± 0.10
	A	0.20 ± 0.10
	B	0.30 ± 0.10
	C	0.35 ± 0.10
	D	0.65 ± 0.10
	E	0.20 ± 0.10
	F	0.20 ± 0.10
	G	0.475 ± 0.10
	H	0.30 ± 0.10

ELECTRICAL CHARACTERISTICS

RFBPB20121G9D0T	Specification
Frequency Range	1880~ 1930 MHz
Insertion Loss	2.5 dB max.
Attenuation	10 dB min. @ 956 ~ 961 MHz 15 dB min. @ 2400 ~ 2500 MHz 20 dB min. @ 2868 ~ 2883 MHz 10 dB min. @ 3824 ~ 3844 MHz 20 dB min. @ 4780 ~ 4805 MHz 20 dB min. @ 5736 ~ 5766 MHz
Phase Difference	$180^0 \pm 15^0$
Amplitude balance	2.0 dB max.
VSWR	2.0 max.
Impedance (Unbalanced)	50 Ω
Impedance (Balanced)	Conjugate match to (20-j18) Ω
Moisture sensitivity levels	LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)

Operating & Storage Condition (Component)

Operation Temperature Range: -40°C ~ +85°C

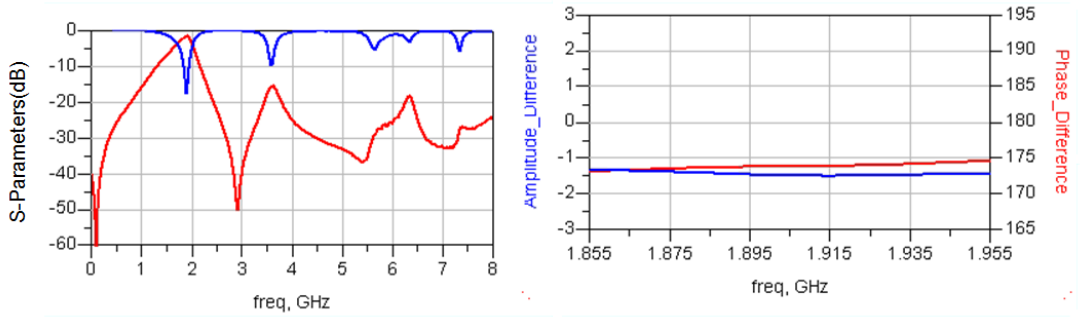
Storage Temperature Range: -40°C ~ +85°C

Storage Condition before Soldering (Included packaging material)

Storage Temperature Range: +5 ~ +40 ℃

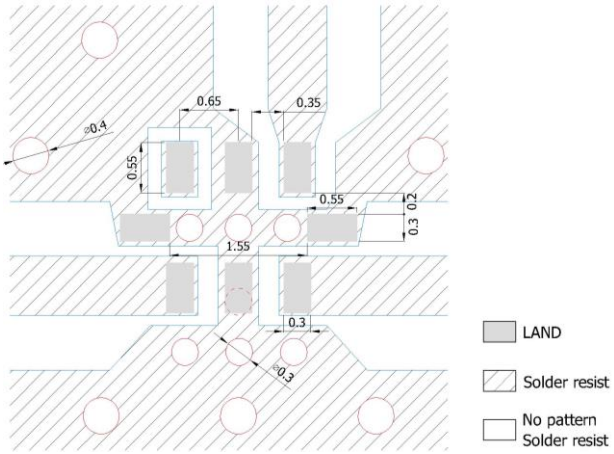
Humidity: 30 to 70% relative humidity

Typical Electrical Chart



SOLDER LAND PATTERN

Figure



Unit : mm

Line width to be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.

RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature：235 ± 5°C *Immersion time：2 ± 0.5 sec Solder：Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature：260 ± 5°C *Leaching immersion time：30 ± 0.5 sec Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature：120~150℃, 1 minute. *Solder temperature：270±5°C *Immersion time：10±1 sec Solder：Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044 Customer's specification.	*Height：75 cm *Test Surface：Rigid surface of concrete or steel. *Times：6 surfaces for each units；2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Vibration JIS C 0040	*Frequency：10Hz~55Hz~10Hz(1min) *Total amplitude：1.5mm *Test times：6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force： 5N(≦0603)；10N(>0603) *Test time：10±1 sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.

Temperature cycle JIS C 0025	1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature：85°C±2°C *Test duration：1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity：90% to 95% R.H. *Temperature：40±2°C *Time：1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature：-40°C±2°C *Test duration：1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

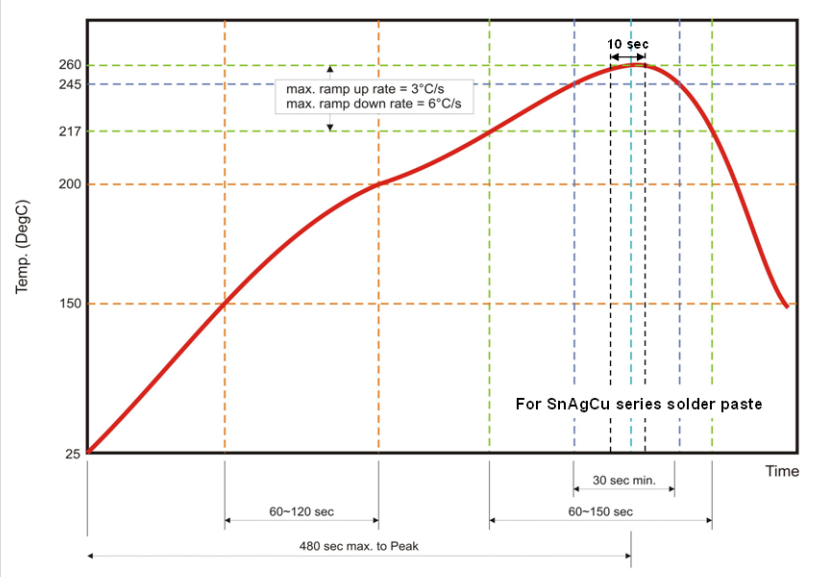


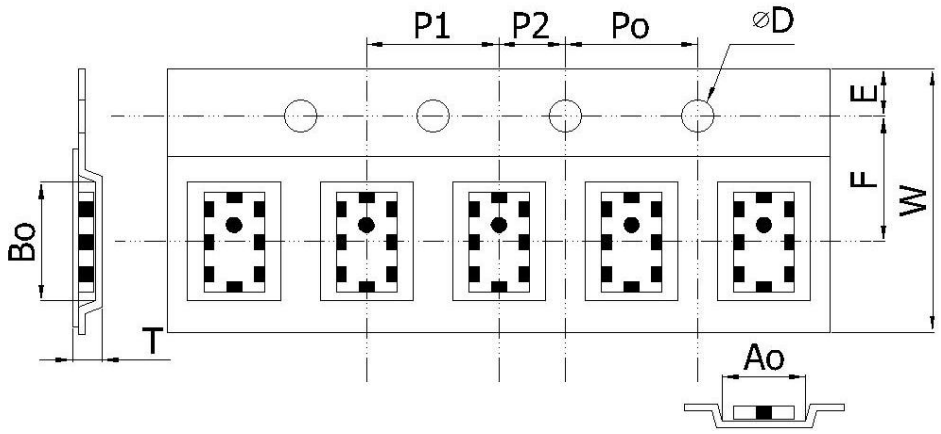
Fig 2. Infrared soldering profile

ORDERING CODE

RF	BPB	2012	1G9	D	0	T
Walsin RF device	**Product Code** BPB : Balanced Type Band Pass Filter	**Dimension code** Per 2 digits of Length, Width, Thickness : e.g. : 2012 = Length 20, Width 12,	**Central Frequency** 1G9 : 1.9 GHz	**Application** D : GSM900 / DSC1800	**Specification** Design Code	**Packing** T : Reeled

Minimum Ordering Quantity: 2000 pcs per reel.

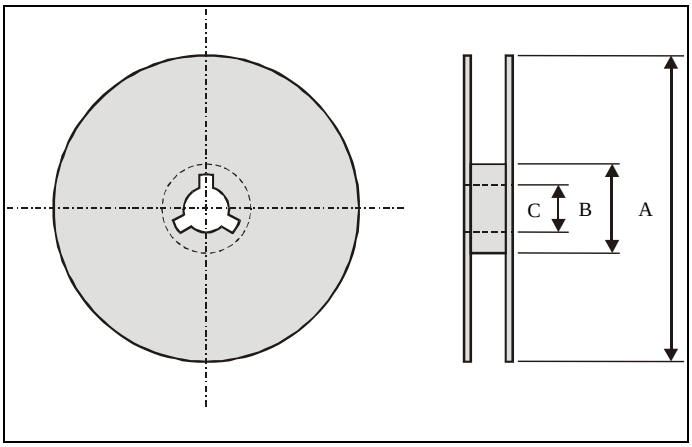
PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Bo	ΦD	T	W
Dimension (mm)	1.30 ± 0.10	2.25 ± 0.10	1.55 ± 0.10	1.10 ± 0.10	8.00 ± 0.30
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions



Index	A	B	C
Dimension (mm)	Φ178.0	Φ60.0	Φ13.0

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

(1) Aircraft equipment
(2) Aerospace equipment
(3) Undersea equipment
(4) Medical equipment
(5) Disaster prevention / crime prevention equipment
(6) Traffic signal equipment
(7) Transportation equipment (vehicles, trains, ships, etc.)
(8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

(1) Products should be used in 6 months from the day of WALSIN outgoing inspection.

(2) Storage environment condition.

- Products should be storage in the warehouse on the following conditions.
- Temperature : +5 to +40℃
- Humidity : 30 to 70% relative humidity
- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.